AEC-Q101 Qualified

4V Drive Nch+Pch MOSFET SP8M10FRA

Structure

Silicon N-channel / P-channel MOSFET

Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small Surface Mount Package (SOP8).

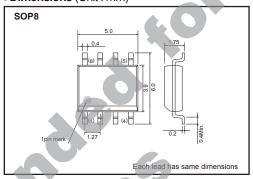
Application

Power switching, DC / DC converter.

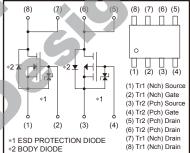
Packaging specifications

	Package	Taping	
Туре	Code	TB	
	Quantity (pcs)	2500	
SP8M10FRA	0		

•Dimensions (Unit : mm)



Equivalent circuit



A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded

●Absolute maximum ratings (Ta=25°C

Туре	Code		ТВ			
	Quantity (p	ocs)	2500			
SP8M10FR	A		0		*2	
●Absolute	maximum	ratings (T	a=25°C)		*1 (1) *1 ESD PRO *2 BODY DIC *A protection d the source ter electricity whe	(2) (3) (4) TECTION DIODE DDE iode is included betw minals to protect the n the product is in u te fixed voltages are
	Parameter	3 - (.		Lin	nits	Unit
	Parameter		Symbol	Nchannel	Pchannel	Unit
Drain-sourc	e voltage		VDSS	30	-30	V
Gate-source	e voltage		V _{GSS}	±20	±20	V
Drain curre	nt	Continuous	-	±7.0	±4.5	A
Drain curren	nı	Pulsed	IDP*1	±28	±18	A
Source curr	rent	Continuous	ls	1.6	-1.6	A
(Body diode			Isp*1	28	-18	Α
	€)	Pulsed	ISP .	20	10	A
Total power	e) r dissipation	Pulsed	PD*2	-	2	W
Total power Channel ter	dissipation	Pulsed			-	

*1 Pw≤10µs, Duty cycle≤1%
*2 MOUNTED ON A CERAMIC BOARD.

Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	Rth (ch-a)*	62.5	°C / W

*MOUNTED ON A CERAMIC BOARD.



SP8M10

Transistors

N-ch

•Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Gate-source leakage	Igss	-	-	±10	μA	V _{GS} =±20V, V _{DS} =0V
Drain-source breakdown voltage	V(BR) DSS	30	-	-	V	I _D =1mA, V _{GS} =0V
Zero gate voltage drain current	IDSS	-	-	1	μΑ	V _{DS} =30V, V _{GS} =0V
Gate threshold voltage	VGS (th)	1.0	-	2.5	V	VDS=10V, ID=1mA
Otatia dasia asuma an atata	*	-	17	25		I _D =7.0A, V _{GS} =10V
Static drain-source on-state resistance	RDS (on)	_	23	35	mΩ	I _D =7.0A, V _{GS} =4.5V
resistance		-	25	37		ID=7.0A, VGS=4V
Forward transfer admittance	Y _{fs} *	5.0		-	S	ID=7.0A, VDs=10V
Input capacitance	Ciss	-	600	-	pF	V _{DS} =10V
Output capacitance	Coss	-	200	-	рF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	120	-	pF	f=1MHz
Turn-on delay time	td (on)*	-	8	-	ns	ID=3.5A, VDD≒15V
Rise time	tr*	-	10	-	ns	V _{GS} =10V
Turn-off delay time	t _{d (off)} *	-	37	-	ns	RL=4.29Ω
Fall time	t _f *	-	11	-	ns	R _G =10Ω
Total gate charge	Qg *	_	8.4	-	nC	VDD=15V
Gate-source charge	Q _{gs} *	-	1.9	-	nC	Vgs=5V
Gate-drain charge	Q _{gd} *	_	3.3	-	nC	Ib=7.0A
Pulsed						

•Body diode characteristics (Source-Drain) (Ta=25°C)

•Body diode characteristics (Source-Drain) (Ta=25°C)							
Parameter	Symbol N	/lin. Typ.	Max.	Unit	Conditions		
Forward voltage	Vsd *		1.2	V	Is=6.4A, Vgs=0V		
*Pulsed	00	0		0			
20							



SP8M10

Transistors

P-ch

Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
	-	IVIIII.				
Gate-source leakage	Igss	-	-	±10	μA	Vgs=±20V, Vds=0V
Drain-source breakdown voltage	V(BR) DSS	-30	_	-	V	$I_D = -1mA$, $V_{GS} = 0V$
Zero gate voltage drain current	IDSS	_	-	-1	μA	$V_{DS}=-30V$, $V_{GS}=0V$
Gate threshold voltage	VGS (th)	-1.0	-	-2.5	V	V_{DS} = -10V, I_{D} = -1mA
	*	-	40	56		I _D = -4.5A, V _G s= -10V
Static drain-source on-state resistance	RDS (on)	-	57	80	mΩ	$I_D = -2.5A, V_{GS} = -4.5V$
resistance		-	65	90		$I_D = -2.5A, V_{GS} = -4.0V$
Forward transfer admittance	Y _{fs} *	3.5		-	S	I _D = -2.5A, V _{DS} = -10V
Input capacitance	Ciss	-	850	_	pF	V _{DS} =-10V
Output capacitance	Coss	-	190	-	pF	V _{GS} =0V
Reverse transfer capacitance	Crss	-	120	-	pF	f=1MHz
Turn-on delay time	td (on)*	-	10	-	ns	I _D = −2.5A, V _{DD} = −15V
Rise time	tr *	_	25	-	ns	V _{GS} =-10V
Turn-off delay time	td (off)*	-	60	-	ns	RL=6.0Ω
Fall time	t _f *	-	25	_	ns	R _G =10Ω
Total gate charge	Qg *	_	8.5	-	nC	VpD≒-15V
Gate-source charge	Q _{gs} *	_	2.5	_	nC	$V_{GS} = -5V$
Gate-drain charge	Q _{gd} *	_	3.0	_	nC	ID=-4.5A
Pulsed						

•Body diode characteristics (Source-Drain) (Ta=25°C)

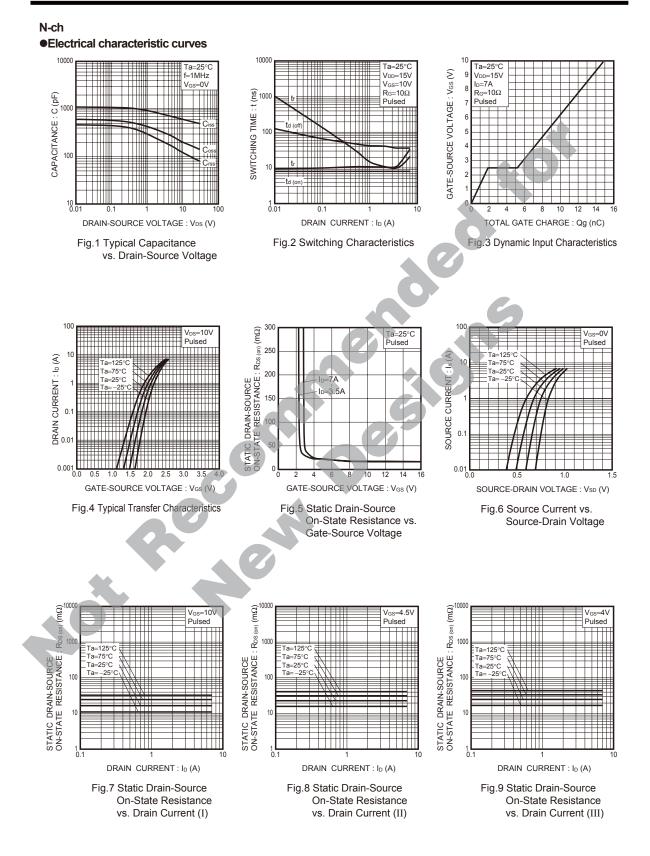
•Body diode characteristics (Source-Drain) (Ta=25°C)								
Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions		
Forward voltage	Vsd			-1.2	V	/Is=-1.6A, V _{GS} =0V		
					0			





Transistors

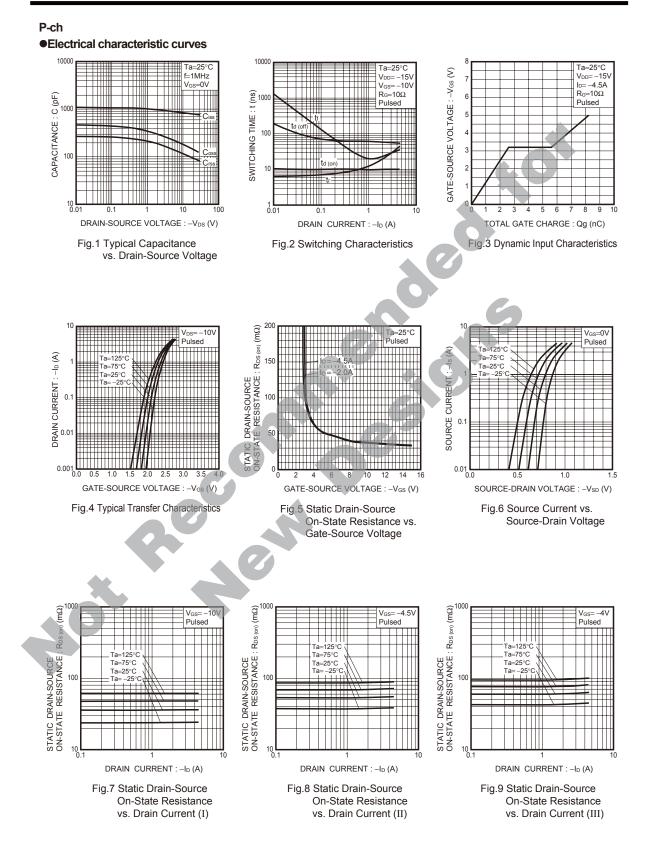
SP8M10





Transistors

SP8M10





Notice

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JAPAN	USA EU		CHINA	
CLASSII	CLASSⅢ	CLASS II b	CLASSI	
CLASSⅣ	CLASSI	CLASSII	CLASSI	

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

[a] Installation of protection circuits or other protective devices to improve system safety

[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

- 3. Our Products are not designed under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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